



MDS75

High-end Power Semiconductor Manufacturer

Three Phases Rectification Bridge Modules**Features:**

- Isolated mounting base 2500V~
- Solder joint technology with Increased power cycling capability
- Space and weight saving

I_o	75 A
V_{RRM}	600-2200 V
I_{FSM}	0.50 KA
I^2t	1.25 10³A²s

Typical Applications

- Inverter
- Inductive heating
- Chopper

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T_j (°C)	VALUE			UNIT
				Min	Type	Max	
I_o	DC output current	Three-phase full wave rectifying circuit, $T_c=100^\circ C$	150			75	A
I_{RRM}	Repetitive peak current	at V_{RRM}	150			8	mA
I_{FSM}	Surge forward current	10ms half sine wave $V_R=0$	150			0.5	kA
I^2t	I^2t for fusing coordination					1.25	10 ³ A ² s
V_{FO}	Threshold voltage		150			0.7	V
r_F	Forward slope resistance					5.0	mW
V_{FM}	Peak forward voltage	$I_{FM}=75A$	25			1.25	V
$R_{th(j-c)}$	Thermal resistance Junction to case	Single side cooled, per total				0.24	°C /W
$R_{th(c-h)}$	Thermal resistance case to heatsink	Single side cooled, per total				0.07	°C /W
V_{iso}	Isolation voltage	50Hz,R.M.S, $t=1min$, $I_{iso}:1mA(max)$		2500			V
F_m	Terminal connection torque(M5)			2.5		4.0	N·m
	Mounting torque(M5)			2.5		4.0	N·m
T_{vj}	Junction temperature			-40		150	°C
T_{stg}	Stored temperature			-40		125	°C
W_t	Weight				135		g
Outline		T13					

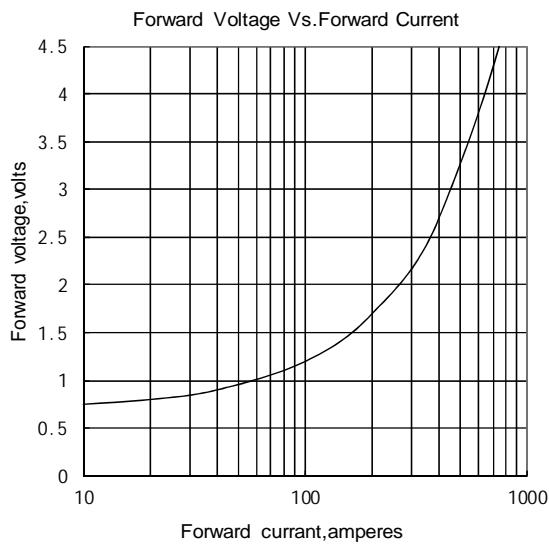


Fig.1

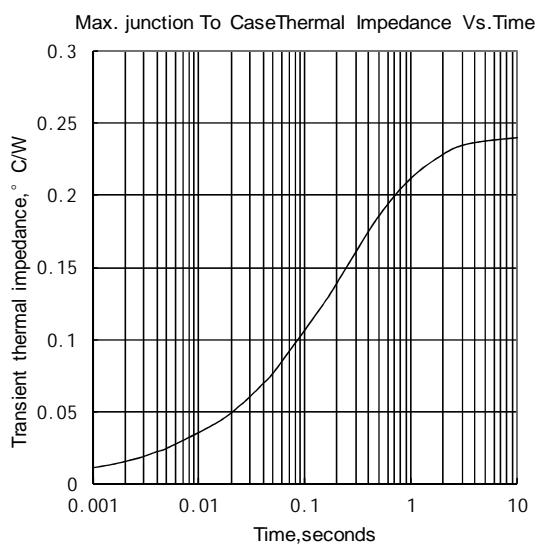


Fig.2

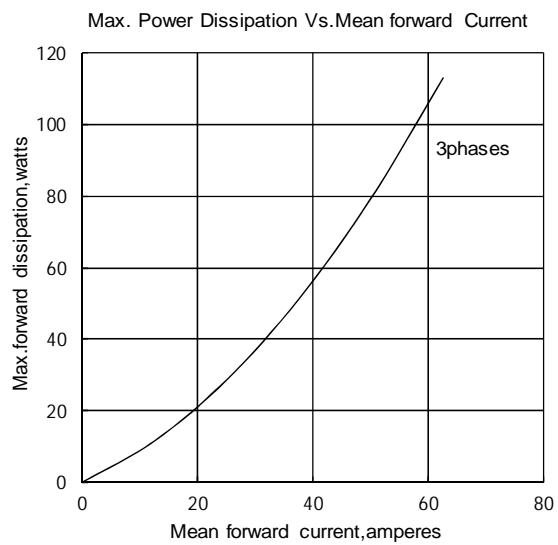


Fig.3

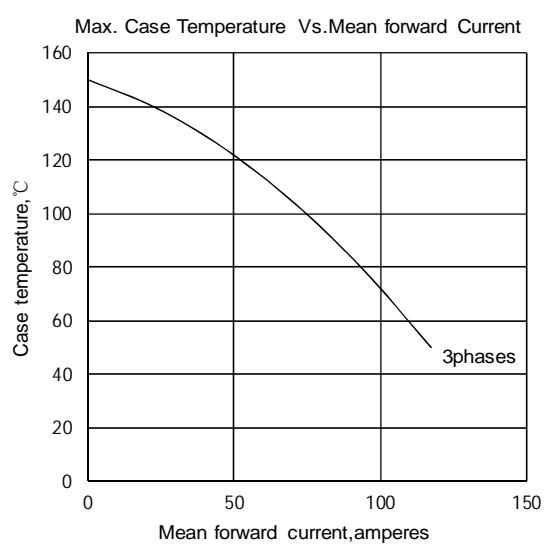


Fig.4

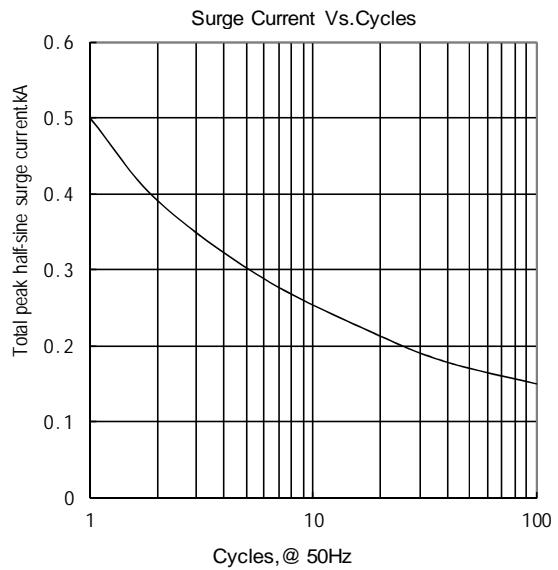


Fig.5

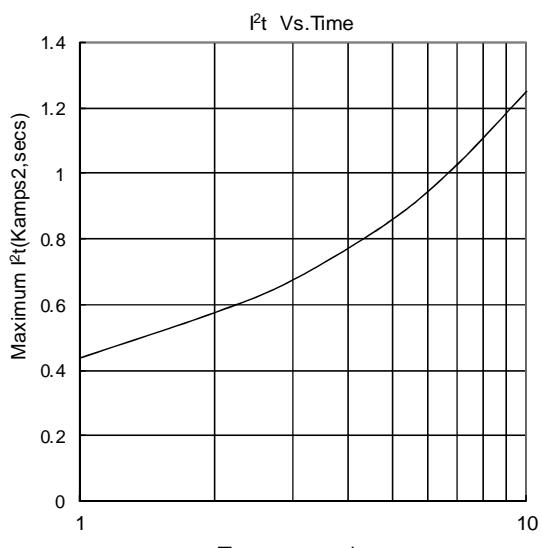
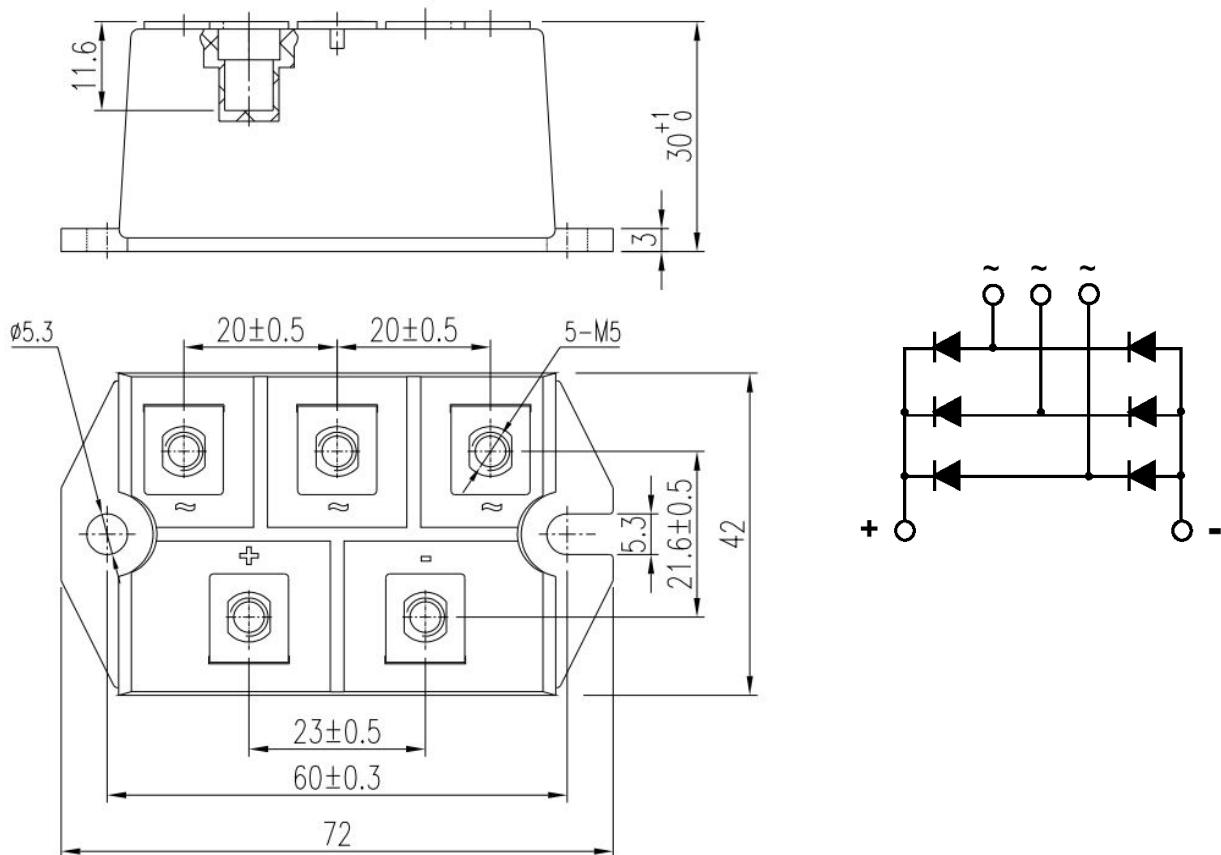


Fig.6

Outline:

Unmarked dimensional tolerance: $\pm 0.5\text{mm}$

T13